

# SAMXON BRAND ALUMINUM ELECTROLYTIC CAPACITORS PRODUCT SPECIFICATION 規格書

<b>CUSTOMER</b> :	•

(客戶): 志盛翔

DATE: (日期):2016-01-18

CATEGORY (品名)	: ALUMINUM ELECTROLYTIC CAPACITORS
DESCRIPTION (型号)	: KM 250V47μF(φ12.5x20)
VERSION (版本)	: 01
Customer P/N	:
SUPPLIER	:

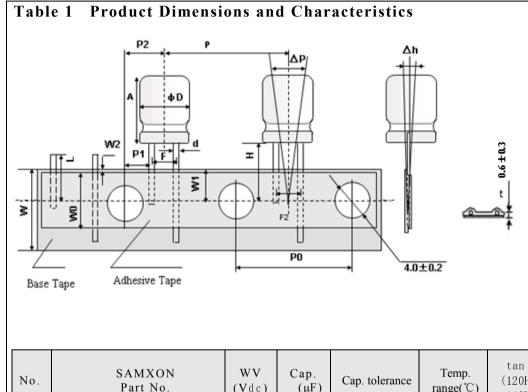
SUPPLI	ER	CUSTOMER					
PREPARED (拟定)			SIGNATURE (签名)				
郭梦玉	王国华						

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

KWI SERIES	ALTERNATION HISTORY RECORDS			
	after Approver			

Name		Specification Sheet – KM				
Version	01		Page	1		
	ST	ANDARD MANUAL				

MAN YUE ELECTRONICS	ELECTROLYTIC CAPACITOR	SAMXON
COMPANY LIMITED	SPECIFICATION KM SERIES	
		·



			Unit:	mm				
Т	aping Coo	le	ТС-Ф12.5(F=5.0)					
D±0.5	A+2.0	d±0.05	P±1.0	P <sub>0</sub> ±0.2	$P_1 \pm 0.5$			
12.5	20	0.6	12.7	12.7	5.0			
P <sub>2</sub> ±1.0	$F_{-0.5}^{+0.8}$	$F_{2}^{+0.8}_{-0.5}$	W $^{+1}_{-0.5}$	$W_0$	W1±0.5			
7.5	5.0	5.0	18	12min	9			
$W_2$	$W_2$ $H^{+0.75}_{-0.5}$		L	riangle h	$\triangle \mathbf{P}$			
3max	18.5		11max	2max	1.3 max			

No.	SAMXON Part No.	WV (Vdc)	Cap. (µF)	Cap. tolerance	Temp. range(℃)	tanδ (120Hz, 20℃)	Leakage Current (µA,2min)	Max Ripple Current at 105°C 100KHz (mA rms)	Impedance at $\geq 27 \ C$ 100kHz ( $\Omega$ )	Load lifetim e (Hrs)	Dime: (n D×L	nsion nm) F	фd	Sleev e
1	EKM476M2EI20TC**Z1	250	47	-20%~+20%	-25~105	0.20	393	375	0.6	2000	12.5X20	5.0	0.6	PET

Issued-date: 2016-01-18		Specification Sheet – KM								
Version	01		Page	2						
	STANDARD MANUAL									

1. Application42. Part Number System43. Construction54. Characteristics6~134.1 Rated voltage & Surge voltage6~134.2 Capacitance (Tolerance)6~134.3 Leakage current44.4 tan δ64.5 Terminal strength64.6 Temperature characteristic74.7 Load life test44.8 Shelf life test44.9 Surge test44.10 Vibration44.11 Solderability test44.13 Change of temperature44.14 Damp heat test44.15 Vent test44.16 Maximum permissible (ripple current)4	<b>CONTENTS</b>	~~
<ul> <li>Part Number System</li> <li>Construction</li> <li>Construction</li> <li>Characteristics</li> <li>Characteristics</li> <li>Characteristics</li> <li>Capacitance (Tolerance)</li> <li>Leakage current</li> <li>Leakage current</li> <li>tan δ</li> <li>Terminal strength</li> <li>Terminal s</li></ul>	1 A 1' .'	Sheet
<ul> <li>3. Construction 5</li> <li>4. Characteristics 6~13</li> <li>4.1 Rated voltage &amp; Surge voltage</li> <li>4.2 Capacitance (Tolerance)</li> <li>4.3 Leakage current</li> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')"</li> </ul>	I. Application	4
<ul> <li>4. Characteristics 6-13</li> <li>4.1 Rated voltage &amp; Surge voltage</li> <li>4.2 Capacitance (Tolerance)</li> <li>4.3 Leakage current</li> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled substances')"</li> </ul>	2. Part Number System	4
<ul> <li>6~13</li> <li>4.1 Rated voltage &amp; Surge voltage</li> <li>4.2 Capacitance (Tolerance)</li> <li>4.3 Leakage current</li> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')"</li> </ul>	3. Construction	5
<ul> <li>4.2 Capacitance (Tolerance)</li> <li>4.3 Leakage current</li> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled substances')"</li> </ul>	4. Characteristics	6~13
<ul> <li>4.3 Leakage current</li> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')"</li> </ul>	4.1 Rated voltage & Surge voltage	
<ul> <li>4.4 tan δ</li> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')"</li> </ul>	4.2 Capacitance (Tolerance)	
<ul> <li>4.5 Terminal strength</li> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')"</li> </ul>	4.3 Leakage current	
<ul> <li>4.6 Temperature characteristic</li> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled Substances')" 14</li> </ul>	4.4 $\tan \delta$	
<ul> <li>4.7 Load life test</li> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14</li> </ul>	4.5 Terminal strength	
<ul> <li>4.8 Shelf life test</li> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14</li> </ul>	-	
<ul> <li>4.9 Surge test</li> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>	4.7 Load life test	
<ul> <li>4.10 Vibration</li> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>	4.8 Shelf life test	
<ul> <li>4.11 Solderability test</li> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>		
<ul> <li>4.12 Resistance to solder heat</li> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>	4.10 Vibration	
<ul> <li>4.13 Change of temperature</li> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>		
<ul> <li>4.14 Damp heat test</li> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>		
<ul> <li>4.15 Vent test</li> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>		
<ul> <li>4.16 Maximum permissible (ripple current)</li> <li>7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"</li> </ul>		
7. List of "Environment-related Substances to be Controlled ('Controlled 14 Substances')"		
	7. List of "Environment-related Substances to be Controlled ('Controlled	14
Attachment. Application Guidennes 15-20		15~20
	Attachment. Application Outdennes	15~20

Name		Specification Sheet – KM						
Version	01		Page	3				
	STANDARD MANUAL							

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

SAMXON

#### 1. Application

This specification applies to polar Aluminum electrolytic capacitor (foil type) used in electronic equipment. Designed capacitor's quality meets IEC60384.

2.	Par	t Numb	oer S	System								
[	1 2	3 4	56	3 7	·	89	ľ	10 11 1:	2 131	14	1516	17
E	EG	S 1	0 5	5 N	1	1 H		D11	— Т (	С	SA	Ρ
	SERIES	CAP		CE TO	L.	VOLTAGE		CASE SIZE	E TYP	E,	SAMXON PRODUCT LINE N	SLEEVE
				I								
	Series	Cap(MFD)	Code	Tolerance (%	) Code	Voltage (W.V.)	Code	Case Size	Feature (	Code	SAMXON Product L	ine
	ESM EKF	0.1	104	±5	J	2	0D 0E	Diameter(	Radial bulk	RR	For internal use only	
	ESS EKS	0.00				4	0E 0G	3.5 1 4 C 5 D	Ammo Tap	ina	(The product lines we have H,A,B,C,D,	
IE	EGS EKM	0.22	224	±10	ĸ	6.3	OJ	6.3   E			E,M or 0,1,2,3,4,5,9	
IF	EKG EOM	0.33	334			8	0K 1A	8 F 10 G	2.0mm Pitch	тт		
IF	EZM EZS	0.47	474	±15	-	12.5	1B	12.5 I 13 J	2.5mm Pitch	τυ		
IF	EGF ESF			±20	м	16 20	1C 1D	13.5 V 14 4	3.5mm Pitch	-		
IF	EGT EGK	1	105	#20		25	1E	14.5 A 16 K	3.5mm Pitch	τv	Sleeve Material	Code
IF	EGE EGD	2.2	225	±30	N	30 32	1I 13	16.5 7 18 L	5.0mm Pitch	тс	PET	P
IF	EGC ERS	3.3	335	-40	1	32	13 1V	18.5 8 20 M	Lead Cut &	Form		
IF	ERF			0	w	40	1G	20 M 22 N 25 O 30 P 34 W 40 R 42 4 45 6 51 S 63.5 T	СВ-Туре	СВ	PVC	If the sleeve material is PVC, there will be blank in seventeenth digit
IF	ERR	4.7	475	-20 0	A	42 50	1M 1H	30 P 34 W	СБ-туре	СВ		slee
IF	ERE	10	106		+	57	1L	35 Q 40 R	CE-Type	CE		Ne II
IF	ERH EBD	22	226	-20 +10	c	63 71	1J 1S	42 4 45 6	HE-Type	HE		nater
IF	ERA ERB		220	-20 +40	x	75	1 <b>T</b>	51 S 63.5 T 76 U	KD-Type	КD		al is
IF	ERC EFA	33	336			80	1K 1R	80 8	КО-туре	KD		8
IF	ENP	47	476	-20 +50	s	90	19	90 X 100 Z	FD-Type	FD		the
IF	ERW	100	107	-10	в	100	2A	Len.(mm) Code 4.5 45 5 05	EH-Type	EH		19 Wi
IF	ELP	100	107	0		120 125	20 2B	5 05 5.4 54				6
IF	EQP	220	227	-10 +20	v	150	2Z	5.4 54 7 07 7.7 77	PCB Term	na		blank
IF	ETP	330	337	-10	Q	160 180	2C 2P	10.2 T2 11 11 11.5 1A		sw		S S
IF	EUP			+30	<u> </u>	200	2D	11.5 1A 12 12 12.5 1B 13 13	Snap-in	sx		even
IF	EEP EFP	470	477	-10 +50	T	215 220	22 2N	12 12 12.5 1B 13 13		07		leent
IF	ESP	2200	228	-5 +10	E	230	23	13.5 1C 20 20 25 25 29.5 2J		sz		hdig
F	EGP	22000	229		+	250 275	2E 2T	25 25 29.5 2J	Lug	SG		F
F	EWU	22000	200	-5 +15	F	300	21	30 30 31.5 3A 35 35		05	L	
IF	EWX	33000	339	-5 +20	G	310	2R	35.5 3E		06		
F	EWS	47000	479	0	R	315 330	2F 2U	50 50 80 80 100 1L		00		
IF	EWL	100000	10T	+20		350	2V	100 1L 105 1K 110 1M	Screw	Т5		
IF	EWB VSS VNS	450000		0 +30	0	360	2X 2Q	120 1N 130 1P	Screw	т6		
F	VKS	150000	15T	0 +50	1	385	2Y	140 1Q 150 1R		D5		
IF	VRL	220000	22T	+50		400 420	2G 2M	155 1E 160 1S		55		
F	VZS VRF	330000	33Т	+15	z	420	2W	165 1F 170 1T		D6		
				+5 +20	D	500 550	2H 25	180 1U 190 1V				
		1000000	10M	+10 +50	Y	600	25	200 2L 215 2A				
		1500000	15M	+50	$\left  \right $	630	2J	040 014				
		2200000	22M	+30	н			210 2M 220 2N 240 2Q 250 2R 260 2S 270 2T				
								260 2S				
L		3300000	33M									

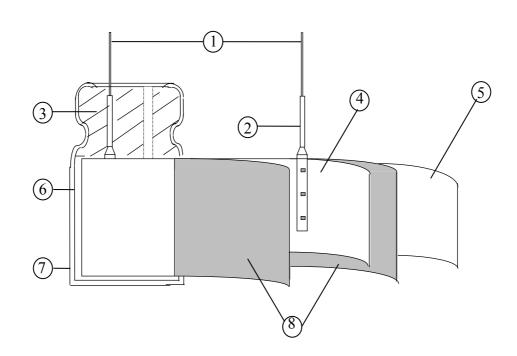
Name		Specification Sheet – KM		
Version	01		Page	4
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

## SAMXON

#### 3. Construction

Single ended type to be produced to fix the terminals to anode and cathode foil, and wind together with paper, and then wound element to be impregnated with electrolyte will be enclosed in an aluminum case. Finally sealed up tightly with end seal rubber, then finished by putting on the vinyl sleeve.



No	Component	Material
1	Lead line	Tinned CP wire (Pb Free)
2	Terminal	Aluminum wire
3	Sealing Material	Rubber
4	Al-Foil (+)	Formed aluminum foil
5	Al-Foil (-)	Etched aluminum foil or formed aluminum foil
6	Case	Aluminum case
7	Sleeve	PVC/PET
8	Separator	Electrolyte paper

Name		Specification Sheet – KM		
Version	01		Page	5
STANDARD MANUAL				

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#### 4. Characteristics

Standard atmospheric conditions

Unless otherwise specified, the standard range of atmospheric conditions for making measurements and tests are as follows:

Ambient temperature	:15°C to 35°C
Relative humidity	: 45% to 85%
Air Pressure	: 86kPa to 106kPa

If there is any doubt about the results, measurement shall be made within the following conditions:Ambient temperature:  $20^{\circ}C \pm 2^{\circ}C$ Relative humidity: 60% to 70%Air Pressure: 86kPa to 106kPa

Operating temperature range

The ambient temperature range at which the capacitor can be operated continuously at rated voltage See table 1 temperature range.

As to the detailed information, please refer to table 2.

Name		Specification Sheet – KM		
Version	01		Page	6
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

Tabl		
	ITEM	PERFORMANCE
	Rated voltage (WV)	
4.1		WV (V.DC)         200         220         250         400         420         450
	Surge voltage (SV)	SV (V.DC)         250         270         300         450         470         500
4.2	Nominal capacitance (Tolerance)	<condition>Measuring Frequency: 120Hz<math>\pm</math>12HzMeasuring Voltage: Not more than 0.5VrmsMeasuring Temperature: <math>20\pm 2^{\circ}C</math><criteria>Shall be within the specified capacitance tolerance.</criteria></condition>
4.3	Leakage current	<b><condition></condition></b> Connecting the capacitor with a protective resistor $(1k \Omega \pm 10 \Omega)$ in series for 2 minutes, and then, measure Leakage Current. <b><criteria></criteria></b> Refer to Table 1
4.4	tan δ	<condition> See 4.2, Norm Capacitance, for measuring frequency, voltage and temperature. <criteria> Refer to Table 1</criteria></condition>

Name		Specification Sheet – KM		
Version	01		Page	7
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

		seconds. Bending Strength of Termina Fixed the capacitor, applied f	Force to the terminal is. Sorce to bent the termination of termination of the termination of te	n lead out direction for $10\pm 1$ nal (1~4 mm from the rubber) ' to its original position within
	Terminal	Diameter of lead wire	Tensile force N	Bending force N
4.5	strength	Over 0.5mm to 0.8mm	(kgf) 10 (1.0)	(kgf) 5 (0.51)
		< <u>Condition</u> >		
	STEP Testing Tempe		Time	
		$1 20\pm 2$		reach thermal equilibrium
		<u>2</u> -25 ±		reach thermal equilibrium
		$3 20\pm 2$		reach thermal equilibrium
				reach thermal equilibrium
4.6	Temperature characteristics	<ul> <li><criteria></criteria></li> <li>a. At +105 °C, capacitance r of its original value at +2 tan δ shall be within the l The leakage current mea value.</li> <li>b. In step 5, tan δ shall be w The leakage current shall</li> </ul>	0°C. imit of Item 4.4 sured shall not more rithin the limit of Item	than 8 times of its specified 4.4

Name		Specification Sheet – KM		
Version	01		Page	8
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

			200, 220	250	400 420	450	1
		Working Voltage (V)	200~220	250	400~420	450	
4.6		Z-25 °C/Z+20 °C For capacitance value >	3 1000 µ E A	$\frac{4}{14.05 \text{ part}}$	6	15 E for 7	] 25°C/7±20°C
		Capacitance, tan $\delta$ , and	A	dd 1.0 per	another 1000 a	↓ F for Z-	40°C/Z+20°C.
		<condition></condition>		.1 1 57			
		According to IEC60384 at a temperature of 105					nula aumant fa
		2000 + 48/0 hours. (Th			01		
		working voltage) The			· ·		
	Load	atmospheric condition					C
.7	life	<criteria></criteria>					
	test	The characteristic sha		-	-		
		Leakage current			be satisfied		
		Capacitance Change			initial value.	· C 1 1	
		tan δ			0% of the spec		ie.
		Appearance	There s	hall be no	leakage of elec	ctrolyte.	
		<condition></condition>					
		The capacitors are then s	stored with no	o voltage a	pplied at a tem	perature	of $105 \pm 2^{\circ}$ C for
		1000+48/0 hours.				-	
		Following this period the				the test of	chamber and be
		allowed to stabilized at r	-				ith D.C. meter
		Next they shall be conn voltage applied for 30m			•		
	Shelf	tested the characteristics		lien the ea	paenors shan	be disent	inged, and then
4.8	life	<criteria></criteria>					
	test	The characteristic shall r					_
		Leakage current		4.3 shall b			
		Capacitance Change			nitial value.		_
		tan δ			% of the specifi		
		Appearance			akage of elect		
		Remark: If the capacitor	rs are stored i	nore than 1	l year, the leak	age curre	nt may increase

Name		Specification Sheet – KM		
Version 01			Page	9
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES



		<condition> Applied a surge voltage to the capacitor connected with a (100 ±50)/C<sub>R</sub> (kΩ) resistor. The capacitor shall be submitted to 1000 cycles, each consisting of charge of 30 ±5s, followed discharge of 5 min 30s. The test temperature shall be 15~35°C. C<sub>R</sub> :Nominal Capacitance ( μ F)</condition>
4.9	Surge test	Criteria>Leakage currentNot more than the specified value.Capacitance ChangeWithin $\pm 15\%$ of initial value. $\tan \delta$ Not more than the specified value.AppearanceThere shall be no leakage of electrolyte.Attention:This test simulates over voltage at abnormal situation only. It is not applicable to such over voltage as often applied.
4.10	Vibration test	Condition> The following conditions shall be applied for 2 hours in each 3 mutually perpendicular directions. Vibration frequency range : 10Hz ~ 55Hz Peak to peak amplitude : 1.5mm Sweep rate : 10Hz ~ 55Hz ~ 10Hz in about 1 minute Mounting method: The capacitor with diameter greater than 12.5mm or longer than 25mm must be fixed in place with a bracket.          4mm or less       Within 30°         4mm or less       To be soldered

Name		Specification Sheet – KM		
Version	01		Page	10
	STA	ANDARD MANUAL		

		<criteria></criteria>					
		After the test, the follow	-				
		Inner construction	Inner construction No intermitte				
				nage of tab terminals or electrodes.			
		<b>A</b> mm a a mm a a		chanical damage in terminal. No leakage			
		Appearance		trolyte or swelling of the case.			
			The markings shall be legible.				
		<condition></condition>	1 1				
		The capacitor shall be test		-			
		Soldering temperature		: 245±3°C : 2mm			
		Dipping depth Dipping speed		: 25±2.5mm/s			
		Dipping time		: 3±0.5s			
		Dipping time		. 5±0.58			
4 1 1	Solderability	<criteria></criteria>					
4.11							
4.11	test			A minimum of 95% of the surface being			
4.11	test	Coating quality		A minimum of 95% of the surface being immersed			
4.11	test	<condition></condition>	r shall be	e			
4.11	test	<condition> Terminals of the capacito</condition>		immersed			
4.11	test	<condition> Terminals of the capacito</condition>		immersed			
4.11	test	Condition> Terminals of the capacito $260 \pm 5^{\circ}$ for $10 \pm 1$ second the body of capacitor .	ds or 400 pe left un	immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 <sup>+1</sup> <sub>-0</sub> seconds to 1.5~2.0mm from der the normal temperature and normal			
4.11	Resistance to	Condition> Terminals of the capacito $260 \pm 5^{\circ} C$ for $10 \pm 1$ second the body of capacitor. Then the capacitor shall be	ds or 400 pe left un	immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 <sup>+1</sup> <sub>-0</sub> seconds to 1.5~2.0mm from der the normal temperature and normal			
4.11	Resistance to solder heat	<condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours be <criteria> Leakage current</criteria></condition>	ds or 400 be left un efore me	immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 <sup>+1</sup> <sub>-0</sub> seconds to 1.5~2.0mm from der the normal temperature and normal asurement.			
	Resistance to	<condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours boots <criteria> Leakage current Capacitance Change</criteria></condition>	ds or 400 be left un efore me Not Wit	immersed immersed into solder bath at $0 \pm 10^{\circ}$ C for3 <sup>+1</sup> <sub>-0</sub> seconds to 1.5~2.0mm from der the normal temperature and normal asurement. immersed			
	Resistance to solder heat	<condition> Terminals of the capacito 260±5°C for10±1second the body of capacitor . Then the capacitor shall the humidity for 1~2 hours be <criteria> Leakage current</criteria></condition>	ds or 400 be left un efore me Not Not	immersed e immersed into solder bath at $0 \pm 10^{\circ}$ C for3 <sup>+1</sup> <sub>-0</sub> seconds to 1.5~2.0mm from der the normal temperature and normal asurement.			

Name		Specification Sheet – KM		
Version	01		Page	11
STANDARD MANUAL				

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

		<condition> Temperature Cycle: According to IEC60384-4No.4.7methods, ca oven, the condition according as below:</condition>	· ·
		Temperature	Time
		(1)+20°C	$\leq 3$ Minutes
		(2)Rated low temperature (-25°C)	$30\pm 2$ Minutes
		(3)Rated high temperature $(+105^{\circ}C)$	$30\pm2$ Minutes
		(1) to (3)=1 cycle, total 5 cycle	
4.13	Change of temperature	<criteria> The characteristic shall meet the following rea</criteria>	quirement
	test	Leakage current Not more than the	e specified value.
		$\tan \delta$ Not more than the	-
		Appearance There shall be no	leakage of electrolyte.
		<condition> Humidity Test: According to IEC60384-4No.4.12 methods, ca be exposed for 500±8 hours in an atmospher</condition>	e of 90~95%R H .at
		Humidity Test: According to IEC60384-4No.4.12 methods, ca	e of 90~95%R H .at
		Humidity Test: According to IEC60384-4No.4.12 methods, ca be exposed for $500\pm 8$ hours in an atmospher $40\pm 2^{\circ}$ C, the characteristic change shall meet <b>Criteria</b> >	e of 90~95%R H .at
		Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for $500 \pm 8$ hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meet <b><criteria></criteria></b> Leakage currentNot more than the sp	e of 90~95%R H .at the following requirement.
4.14	Damp	Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for $500 \pm 8$ hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meetCriteria>Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of in	e of 90~95%R H .at the following requirement. pecified value.
4.14	heat	Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for $500 \pm 8$ hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meet <b><criteria></criteria></b> Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of intan $\delta$ Not more than 120\%	e of 90~95%R H .at the following requirement. eccified value. itial value. o f the specified value.
4.14	1	Humidity Test:According to IEC60384-4No.4.12 methods, carbe exposed for $500 \pm 8$ hours in an atmospher $40 \pm 2^{\circ}$ C, the characteristic change shall meetCriteria>Leakage currentNot more than the spCapacitance ChangeWithin $\pm 20\%$ of in	e of 90~95%R H .at the following requirement. ecified value. itial value. o f the specified value.

Name		Specification Sheet – KM		
Version	01		Page	12
	STA	ANDARD MANUAL		

#### ELECTROLYTIC CAPACITOR SPECIFICATION KM SERIES

4.15	Vent test	<condition> The following test only apply to those products with vent products at diameter ≥Ø6.3 with vent. D.C. test The capacitor is connected with its polarity reversed to a DC power source. Then a current selected from below table is applied. <table 3=""> </table></condition>
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Name		Specification Sheet – KM		
Version	01		Page	13
	STA	ANDARD MANUAL		

# 5. It refers to the latest document of "Environment-related Substances standard" (WI-HSPM-QA-072).

	Substances		
	Cadmium and cadmium compounds		
Heavy metals	Lead and lead compounds		
ficavy metals	Mercury and mercury compounds		
	Hexavalent chromium compounds		
	Polychlorinated biphenyls (PCB)		
Chloinated	Polychlorinated naphthalenes (PCN)		
organic	Polychlorinated terphenyls (PCT)		
compounds	Short-chain chlorinated paraffins(SCCP)		
	Other chlorinated organic compounds		
D · (1	Polybrominated biphenyls (PBB)		
Brominated	Polybrominated diphenylethers(PBDE) (including		
organic	decabromodiphenyl ether[DecaBDE])		
compounds	Other brominated organic compounds		
Tributyltin comp	oounds(TBT)		
Triphenyltin con	npounds(TPT)		
Asbestos			
Specific azo con	npounds		
Formaldehyde			
Beryllium oxide			
Beryllium copp	er		
Specific phthalat	tes (DEHP,DBP,BBP,DINP,DIDP,DNOP,DNHP)		
Hydrofluorocarb	on (HFC), Perfluorocarbon (PFC)		
Perfluorooctane	sulfonates (PFOS)		
Specific Benzotr	iazole		

Name		Specification Sheet – KM		
Version	01		Page	14
STANDARD MANUAL				



#### **Attachment: Application Guidelines**

#### **1.Circuit Design**

1.1 Operating Temperature and Frequency

Electrolytic capacitor electrical parameters are normally specified at  $20^{\circ}$ C temperature and 120Hz frequency. These parameters vary with changes in temperature and frequency. Circuit designers should take these changes into consideration.

- (1) Effects of operating temperature on electrical parameters
  - a) At higher temperatures, leakage current and capacitance increase while equivalent series resistance (ESR) decreases.
  - b) At lower temperatures, leakage current and capacitance decrease while equivalent series resistance (ESR) increases.
- (2) Effects of frequency on electrical parameters
  - a) At higher frequencies capacitance and impedance decrease while tan  $\delta$  increases.
  - b) At lower frequencies, ripple current generated heat will rise due to an increase in equivalent series resistance (ESR).
- 1.2 Operating Temperature and Life Expectancy See the file: Life calculation of aluminum electrolytic capacitor
- 1.3 Common Application Conditions to Avoid The following misapplication load conditions will cause rapid deterioration to capacitor electrical parameters. In addition, rapid heating and gas generation within the capacitor can occur causing the pressure relief vent to operate and resultant leakage of electrolyte. Under Leaking electrolyte is combustible and electrically conductive.

Name		Specification Sheet – KM		
Version	01		Page	15
	STA	ANDARD MANUAL		

#### (1) Reverse Voltage

DC capacitors have polarity. Verify correct polarity before insertion. For circuits with changing or uncertain polarity, use DC bipolar capacitors. DC bipolar capacitors are not suitable for use in AC circuits.

(2) Charge / Discharge Applications

Standard capacitors are not suitable for use in repeating charge / discharge applications. For charge / discharge applications consult us and advise actual conditions.

#### (3) Over voltage

Do not apply voltages exceeding the maximum specified rated voltage. Voltages up to the surge voltage rating are acceptable for short periods of time. Ensure that the sum of the DC voltage and the superimposed AC ripple voltage does not exceed the rated voltage.

(4) Ripple Current

Do not apply ripple currents exceeding the maximum specified value. For high ripple current applications, use a capacitor designed for high ripple currents or contact us with your requirements. Ensure that allowable ripple currents superimposed on low DC bias voltages do not cause reverse voltage conditions.

- 1.4 Using Two or More Capacitors in Series or Parallel
- (1) Capacitors Connected in Parallel

The circuit resistance can closely approximate the series resistance of the capacitor causing an imbalance of ripple current loads within the capacitors. Careful design of wiring methods can minimize the possibility of excessive ripple currents applied to a capacitor.

- (2) Capacitors Connected in Series Normal DC leakage current differences among capacitors can cause voltage imbalances. The use of voltage divider shunt resistors with consideration to leakage current can prevent capacitor voltage imbalances.
- 1.5 Capacitor Mounting Considerations
- (1) Double Sided Circuit Boards

Avoid wiring pattern runs, which pass between the mounted capacitor and the circuit board. When dipping into a solder bath, excess solder may collect under the capacitor by capillary action and short circuit the anode and cathode terminals.

#### (2)Circuit Board Hole Positioning

The vinyl sleeve of the capacitor can be damaged if solder passes through a lead hole for subsequently processed parts. Special care when locating hole positions in proximity to capacitors is recommended.

(3)Circuit Board Hole Spacing

The circuit board holes spacing should match the capacitor lead wire spacing within the specified tolerances. Incorrect spacing can cause excessive lead wire stress during the insertion process. This may result in premature capacitor failure due to short or open circuit, increased leakage current, or electrolyte leakage.

Name		Specification Sheet – KM		
Version	01		Page	16
STANDARD MANUAL				

<ul> <li>(4) Clearance for Case Mounted Pressure Relief vents</li> <li>Capacitors with case mounted pressure relief vents require sufficient clearance to allow for proper vent operation. The minimum clearances are dependent on capacitor diameters as proper vent operation. The minimum clearances are dependent on capacitor diameters as follows.</li> <li>              Φ 6.3~ Φ 16mm:2mm minimum, Φ 18~ Φ 35mm:3mm minimum, Φ 40mm or greater:5mm minimum.      </li> </ul>
<ul><li>(5) Clearance for Seal Mounted Pressure Relief Vents</li><li>A hole in the circuit board directly under the seal vent location is required to allow proper release of pressure.</li></ul>
(6) Wiring Near the Pressure Relief Vent Avoid locating high voltage or high current wiring or circuit board paths above the pressure relief vent. Flammable, high temperature gas exceeding 100°C may be released which could dissolve the wire insulation and ignite.
<ul> <li>(7) Circuit Board patterns Under the Capacitor Avoid circuit board runs under the capacitor as electrolyte leakage could cause an electrical short.</li> </ul>
<ul> <li>(8) Screw Terminal Capacitor Mounting Do not orient the capacitor with the screw terminal side of the capacitor facing downwards. Tighten the terminal and mounting bracket screws within the torque range specified in the specification.</li> </ul>
<ol> <li>1.6 Electrical Isolation of the Capacitor Completely isolate the capacitor as follows.</li> <li>(1) Between the cathode and the case (except for axially leaded B types) and between the anode terminal and other circuit paths</li> </ol>
<ul><li>(2) Between the extra mounting terminals (on T types) and the anode terminal, cathode terminal, and other circuit paths.</li></ul>
<ul> <li>1.7 The Product endurance should take the sample as the standard.</li> <li>1.8 If conduct the load or shelf life test, must be collect date code within 6 months products of sampling.</li> <li>1.9 Capacitor Sleeve</li> </ul>
The vinyl sleeve or laminate coating is intended for marking and identification purposes and is not meant to electrically insulate the capacitor. The sleeve may split or crack if immersed into solvents such as toluene or xylene, and then exposed to high temperatures.
CAUTION! Always consider safety when designing equipment and circuits. Plan for worst case failure modes such as short circuits and open circuits which could occur during use. (1) Provide protection circuits and protection devices to allow safe failure modes. (2) Design redundant or secondary circuits where possible to assure continued operation in case of main circuit failure.

Name		Specification Sheet – KM				
Version	01		Page	17		
STANDARD MANUAL						

#### 2. Capacitor Handling Techniques

- 2.1 Considerations Before Using
- (1) Capacitors have a finite life. Do not reuse or recycle capacitors from used equipment.
- (2) Transient recovery voltage may be generated in the capacitor due to dielectric absorption. If required, this voltage can be discharged with a resistor with a value of about  $1k \Omega$ .
- (3) Capacitors stored for long periods of time may exhibit an increase in leakage current. This can be corrected by gradually applying rated voltage in series with a resistor of approximately  $1k \Omega$ .
- (4) If capacitors are dropped, they can be damaged mechanically or electrically. Avoid using dropped capacitors.
- (5) Dented or crushed capacitors should not be used. The seal integrity can be compromised and loss of electrolyte / shortened life can result.
- 2.2 Capacitor Insertion
- \* (1) Verify the correct capacitance and rated voltage of the capacitor.
- \* (2) Verify the correct polarity of the capacitor before inserting.
- \* (3) Verify the correct hole spacing before insertion (land pattern size on chip type) to avoid stress on the terminals.
  (4) Ensure that the auto insertion equipment lead clinching operation does not stress the capacitor leads where they enter the seal of the capacitor.

For chip type capacitors, excessive mounting pressure can cause high leakage current, short circuit, or disconnection.

#### 2.3 Manual Soldering

- (1) Observe temperature and time soldering specifications or do not exceed temperatures of 400  $^\circ$ C for 3 seconds or less.
- (2) If lead wires must be formed to meet terminal board hole spacing, avoid stress on the lead wire where it enters the capacitor seal.
- (3) If a soldered capacitor must be removed and reinserted, avoid excessive stress to the capacitor leads.
- (4) Avoid touching the tip of the soldering iron to the capacitor, to prevent melting of the vinyl sleeve.

#### 2.4 Flow Soldering

- (1) Do not immerse the capacitor body into the solder bath as excessive internal pressure could result.
- (2) Observe proper soldering conditions (temperature, time, etc.) Do not exceed the specified limits.
- (3) Do not allow other parts or components to touch the capacitor during soldering.

#### 2.5 Other Soldering Considerations

Rapid temperature rises during the preheat operation and resin bonding operation can cause cracking of the capacitor vinyl sleeve.

For heat curing, do not exceed 150°C for a maximum time of 2 minutes.

Name		Specification Sheet – KM				
Version	01		Page	18		
STANDARD MANUAL						

#### 2.6 Capacitor Handling after Solder

- (1). Avoid movement of the capacitor after soldering to prevent excessive stress on the lead wires where they enter the seal.
- (2). Do not use capacitor as a handle when moving the circuit board assembly.
- (3). Avoid striking the capacitor after assembly to prevent failure due to excessive shock.

2.7 Circuit Board Cleaning

- \* (1) Circuit boards can be immersed or ultrasonically cleaned using suitable cleaning solvents for up 5 minutes and up to 60°C maximum temperatures. The boards should be thoroughly rinsed and dried.
- The use of ozone depleting cleaning agents is not recommended in the interest of protecting the environment.
- \* (2) Avoid using the following solvent groups unless specifically allowed for in the specification;
- Halogenated cleaning solvents: except for solvent resistant capacitor types, halogenated solvents can permeate the seal and cause internal capacitor corrosion and failure. For solvent resistant capacitors, carefully follow the temperature and time requirements of the specification. 1-1-1 trichloroethane should never be used on any aluminum electrolytic capacitor.
- . Alkali solvents : could attack and dissolve the aluminum case.
- . Petroleum based solvents: deterioration of the rubber seal could result.
- . Xylene : deterioration of the rubber seal could result.
- Acetone : removal of the ink markings on the vinyl sleeve could result.
- \* (3) A thorough drying after cleaning is required to remove residual cleaning solvents which may be trapped between the capacitor and the circuit board. Avoid drying temperatures, which exceed the maximum rated temperature of the capacitor.
- \* (4) Monitor the contamination levels of the cleaning solvents during use by electrical conductivity, pH, specific gravity, or water content. Chlorine levels can rise with contamination and adversely affect the performance of the capacitor.

Please consult us for additional information about acceptable cleaning solvents or cleaning methods.

2.8 Mounting Adhesives and Coating Agents

When using mounting adhesives or coating agents to control humidity, avoid using materials containing halogenated solvents. Also, avoid the use of chloroprene based polymers.

After applying adhesives or coatings, dry thoroughly to prevent residual solvents from being trapped between the capacitor and the circuit board.

#### **3.** Precautions for using capacitors

3.1 Environmental Conditions

- Capacitors should not be stored or used in the following environments.
- \* (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- \* (2) Direct contact with water, salt water, or oil.
- \* (3) High humidity conditions where water could condense on the capacitor.

Name		Specification Sheet – KM				
Version	01		Page	19		
STANDARD MANUAL						



- \* (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid chlorine, or ammonia.
- \* (5) Exposure to ozone, radiation, or ultraviolet rays.
- \* (6) Vibration and shock conditions exceeding specified requirements.

#### **3.2 Electrical Precautions**

- (1) Avoid touching the terminals of the capacitor as possible electric shock could result. The exposed aluminum case is not insulated and could also cause electric shock if touched.
- (2) Avoid short circuit the area between the capacitor terminals with conductive materials including liquids such as acids or alkaline solutions.

#### 4. Emergency Procedures

- (1) If the pressure relief vent of the capacitor operates, immediately turn off the equipment and disconnect form the power source. This will minimize additional damage caused by the vaporizing electrolyte.
- (2) Avoid contact with the escaping electrolyte gas which can exceed 100°C temperatures.
  If electrolyte or gas enters the eye, immediately flush the eyes with large amounts of water.
  If electrolyte or gas is ingested by month, gargle with water.
  If electrolyte contacts the skin, wash with soap and water.

#### 5. Long Term Storage

Leakage current of a capacitor increases with long storage times. The aluminum oxide film deteriorates as a function of temperature and time. If used without reconditioning, an abnormally high current will be required to restore the oxide film. This current surge could cause the circuit or the capacitor to fail.

After one year, a capacitor should be reconditioned by applying rated voltage in series with a  $1000 \Omega$ , current limiting resistor for a time period of 30 minutes .

If the expired date of products date code is over eighteen months, the products should be return to confirmation. 5.1 Environmental Conditions

The capacitor shall be not use in the following condition:

- (1) Temperature exposure above the maximum rated or below the minimum rated temperature of the capacitor.
- (2) Direct contact with water, salt water, or oil.
- (3) High humidity conditions where water could condense on the capacitor.
- (4) Exposure to toxic gases such as hydrogen sulfide, sulfuric acid, nitric acid, chlorine, or ammonia.
- (5) Exposure to ozone, radiation, or ultraviolet rays.
- (6) Vibration and shock conditions exceeding specified requirements.

#### 6. Capacitor Disposal

When disposing of capacitors, use one of the following methods.

\* Incinerate after crushing the capacitor or puncturing the can wall (to prevent explosion due to internal pressure rise). Capacitors should be incinerated at high temperatures to prevent the release of toxic gases such as chlorine from the polyvinyl chloride sleeve, etc.

Dispose of as solid waste.
 NOTE: Local laws may have specific disposal requirements, which must be followed.

Name		Specification Sheet – KM				
Version	01		Page	20		
STANDARD MANUAL						